



±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

General Description

The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E +3.0V-powered EIA/TIA-232 and V.28/V.24 communications interface devices feature low power consumption, high data-rate capabilities, and enhanced electrostatic-discharge (ESD) protection. The enhanced ESD structure protects all transmitter outputs and receiver inputs to ±15kV using IEC 1000-4-2 Air-Gap Discharge, ±8kV using IEC 1000-4-2 Contact Discharge (±9kV for MAX3246E), and ±15kV using the Human Body Model. The logic and receiver I/O pins of the MAX3237E are protected to the above standards, while the transmitter output pins are protected to ±15kV using the Human Body Model.

A proprietary low-dropout transmitter output stage delivers true RS-232 performance from a +3.0V to +5.5V power supply, using an internal dual charge pump. The charge pump requires only four small 0.1µF capacitors for operation from a +3.3V supply. Each device guarantees operation at data rates of 250kbps while maintaining RS-232 output levels. The MAX3237E guarantees operation at 250kbps in the normal operating mode and 1Mbps in the MegaBaud™ operating mode, while maintaining RS-232-compliant output levels.

The MAX3222E/MAX3232E have two receivers and two transmitters. The MAX3222E features a 1µA shutdown mode that reduces power consumption in battery-powered portable systems. The MAX3222E receivers remain active in shutdown mode, allowing monitoring of external devices while consuming only 1µA of supply current. The MAX3222E and MAX3232E are pin, package, and functionally compatible with the industry-standard MAX242 and MAX232, respectively.

The MAX3241E/MAX3246E are complete serial ports (three drivers/five receivers) designed for notebook and subnotebook computers. The MAX3237E (five drivers/three receivers) is ideal for peripheral applications that require fast data transfer. These devices feature a shutdown mode in which all receivers remain active, while consuming only 1µA (MAX3241E/MAX3246E) or 10nA (MAX3237E).

The MAX3222E, MAX3232E, and MAX3241E are available in space-saving SO, SSOP, TQFN and TSSOP packages. The MAX3237E is offered in an SSOP package. The MAX3246E is offered in the ultra-small 6 x 6 UCSP™ package.

Applications

Battery-Powered Equipment	Printers
Cell Phones	Smart Phones
Cell-Phone Data Cables	xDSL Modems
Notebook, Subnotebook, and Palmtop Computers	

Next-Generation Device Features

- ◆ For Space-Constrained Applications
MAX3228E/MAX3229E: ±15kV ESD-Protected, +2.5V to +5.5V, RS-232 Transceivers in UCSP
- ◆ For Low-Voltage or Data Cable Applications
MAX3380E/MAX3381E: +2.35V to +5.5V, 1µA, 2Tx/2Rx, RS-232 Transceivers with ±15kV ESD-Protected I/O and Logic Pins

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX3222ECTP	0°C to +70°C	20 Thin QFN-EP** (5mm x 5mm)	T2055-5
MAX3222ECUP	0°C to +70°C	20 TSSOP	—
MAX3222ECAP	0°C to +70°C	20 SSOP	—
MAX3222ECWN	0°C to +70°C	18 Wide SO	—
MAX3222ECPN	0°C to +70°C	18 Plastic DIP	—
MAX3222EC/D	0°C to +70°C	Dice*	—
MAX3222EETP	-40°C to +85°C	20 Thin QFN-EP** (5mm x 5mm)	T2055-5
MAX3222EEUP	-40°C to +85°C	20 TSSOP	—
MAX3222EEAP	-40°C to +85°C	20 SSOP	—
MAX3222EEWN	-40°C to +85°C	18 Wide SO	—
MAX3222EEPN	-40°C to +85°C	18 Plastic DIP	—
MAX3232ECAE	0°C to +70°C	16 SSOP	—
MAX3232ECWE	0°C to +70°C	16 Wide SO	—
MAX3232ECPE	0°C to +70°C	16 Plastic DIP	—

*Dice are tested at $T_A = +25^\circ\text{C}$, DC parameters only.

**EP = Exposed paddle.

Ordering Information continued at end of data sheet.

Pin Configurations, Selector Guide, and Typical Operating Circuits appear at end of data sheet.

MegaBaud and UCSP are trademarks of Maxim Integrated Products, Inc.

†Covered by U.S. Patent numbers 4,636,930; 4,679,134; 4,777,577; 4,797,899; 4,809,152; 4,897,774; 4,999,761; and other patents pending.

MAX3222E/MAX3232E/MAX3237E/MAX3241E†/MAX3246E



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ABSOLUTE MAXIMUM RATINGS

V _{CC} to GND	-0.3V to +6V	18-Pin PDIP (derate 11.11mW/°C above +70°C).....	889mW
V+ to GND (Note 1)	-0.3V to +7V	20-Pin TQFN (derate 21.3mW/°C above +70°C)	1702mW
V- to GND (Note 1)	+0.3V to -7V	20-Pin TSSOP (derate 10.9mW/°C above +70°C)	879mW
V+ + IV-I (Note 1).....	+13V	20-Pin SSOP (derate 8.00mW/°C above +70°C)	640mW
Input Voltages		28-Pin SSOP (derate 9.52mW/°C above +70°C)	762mW
T _{IN} , $\overline{\text{EN}}$, $\overline{\text{SHDN}}$, MBAUD to GND	-0.3V to +6V	28-Pin Wide SO (derate 12.50mW/°C above +70°C).....	1W
R _{IN} to GND	±25V	28-Pin TSSOP (derate 12.8mW/°C above +70°C)	1026mW
Output Voltages		32-Lead Thin QFN (derate 33.3mW/°C above +70°C)..	2666mW
T _{OUT} to GND	±13.2V	6 x 6 UCSP (derate 12.6mW/°C above +70°C)	1010mW
R _{OUT} , R _{OUTB} (MAX3241E).....	-0.3V to (V _{CC} + 0.3V)	Operating Temperature Ranges	
Short-Circuit Duration, T _{OUT} to GND.....	Continuous	MAX32__EC__	0°C to +70°C
Continuous Power Dissipation (T _A = +70°C)		MAX32__EE__	-40°C to +85°C
16-Pin SSOP (derate 7.14mW/°C above +70°C)	571mW	Storage Temperature Range	-65°C to +150°C
16-Pin TSSOP (derate 9.4mW/°C above +70°C)	754.7mW	Lead Temperature (soldering, 10s)	+300°C
16-Pin TQFN (derate 20.8mW/°C above +70°C)	1666.7mW	Bump Reflow Temperature (Note 2)	
16-Pin Wide SO (derate 9.52mW/°C above +70°C)	762mW	Infrared, 15s.....	+200°C
18-Pin Wide SO (derate 9.52mW/°C above +70°C)	762mW	Vapor Phase, 20s.....	+215°C

Note 1: V+ and V- can have maximum magnitudes of 7V, but their absolute difference cannot exceed 13V.

Note 2: This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board-level solder attach and rework. This limit permits only the use of the solder profiles recommended in the industry-standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow. Preheating is required. Hand or wave soldering is not allowed.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +3V to +5.5V, C1–C4 = 0.1µF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
DC CHARACTERISTICS (V _{CC} = +3.3V or +5V, T _A = +25°C)						
Supply Current	$\overline{\text{SHDN}}$ = V _{CC} , no load	MAX3222E, MAX3232E, MAX3241E, MAX3246E		0.3	1	mA
		MAX3237E		0.5	2.0	
Shutdown Supply Current	$\overline{\text{SHDN}}$ = GND			1	10	µA
	$\overline{\text{SHDN}}$ = R _{IN} = GND, T _{IN} = GND or V _{CC} (MAX3237E)			10	300	
LOGIC INPUTS						
Input Logic Low	T _{IN} , $\overline{\text{EN}}$, $\overline{\text{SHDN}}$, MBAUD				0.8	V
Input Logic High	T _{IN} , $\overline{\text{EN}}$, $\overline{\text{SHDN}}$, MBAUD	V _{CC} = +3.3V		2.0		V
		V _{CC} = +5.0V		2.4		
Transmitter Input Hysteresis				0.5		V
Input Leakage Current	T _{IN} , $\overline{\text{EN}}$, $\overline{\text{SHDN}}$	MAX3222E, MAX3232E, MAX3241E, MAX3246E		±0.01	±1	µA
	T _{IN} , $\overline{\text{SHDN}}$, MBAUD	MAX3237E (Note 5)		9	18	
RECEIVER OUTPUTS						
Output Leakage Current	R _{OUT} (MAX3222E/MAX3237E/MAX3241E/MAX3246E), $\overline{\text{EN}}$ = V _{CC} , receivers disabled			±0.05	±10	µA
Output-Voltage Low	I _{OUT} = 1.6mA (MAX3222E/MAX3232E/MAX3241E/MAX3246E), I _{OUT} = 1.0mA (MAX3237E)				0.4	V

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ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +3V to +5.5V, C1–C4 = 0.1μF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 3, 4)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Output-Voltage High	I _{OUT} = -1.0mA		V _{CC} - 0.6	V _{CC} - 0.1		V
RECEIVER INPUTS						
Input Voltage Range			-25		+25	V
Input Threshold Low	T _A = +25°C	V _{CC} = +3.3V	0.6	1.1		V
		V _{CC} = +5.0V	0.8	1.5		
Input Threshold High	T _A = +25°C	V _{CC} = +3.3V		1.5	2.4	V
		V _{CC} = +5.0V		2.0	2.4	
Input Hysteresis				0.5		V
Input Resistance	T _A = +25°C		3	5	7	kΩ
TRANSMITTER OUTPUTS						
Output Voltage Swing	All transmitter outputs loaded with 3kΩ to ground (Note 6)		±5	±5.4		V
Output Resistance	V _{CC} = 0, transmitter output = ±2V		300	50k		Ω
Output Short-Circuit Current					±60	mA
Output Leakage Current	V _{CC} = 0 or +3.0V to +5.5V, V _{OUT} = ±12V, transmitters disabled (MAX3222E/MAX3232E/MAX3241E/MAX3246E)				±25	μA
MOUSE DRIVABILITY (MAX3241E)						
Transmitter Output Voltage	T1IN = T2IN = GND, T3IN = V _{CC} , T3OUT loaded with 3kΩ to GND, T1OUT and T2OUT loaded with 2.5mA each		±5			V
ESD PROTECTION						
R _{IN} , T _{OUT}	Human Body Model			±15		kV
	IEC 1000-4-2 Air-Gap Discharge (except MAX3237E)			±15		
	IEC 1000-4-2 Contact Discharge (except MAX3237E)			±8		
	IEC 1000-4-2 Contact Discharge (MAX3246E only)			±9		
T _{IN} , R _{IN} , R _{OUT} , \overline{EN} , \overline{SHDN} , M _{BAUD}	MAX3237E	Human Body Model		±15		kV
		IEC1000-4-2 Air-Gap Discharge		±15		
		IEC1000-4-2 Contact Discharge		±8		

MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

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TIMING CHARACTERISTICS—MAX3222E/MAX3232E/MAX3241E/MAX3246E

(V_{CC} = +3V to +5.5V, C₁–C₄ = 0.1μF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 3, 4)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Maximum Data Rate		R _L = 3kΩ, C _L = 1000pF, one transmitter switching	T _A = T _{MIN} to T _{MAX} (MAX3222E/MAX3232E/MAX3241E) (Note 6)	250			kbps
			T _A = +25°C (MAX3246E)	250			
Receiver Propagation Delay	t _{PHL}	Receiver input to receiver output, C _L = 150pF		0.15			μs
	t _{PLH}			0.15			
Receiver Output Enable Time		Normal operation (except MAX3232E)		200			ns
Receiver Output Disable Time		Normal operation (except MAX3232E)		200			ns
Transmitter Skew	t _{PHL} - t _{PLH}	(Note 7)		100			ns
Receiver Skew	t _{PHL} - t _{PLH}			50			ns
Transition-Region Slew Rate		V _{CC} = +3.3V, T _A = +25°C, R _L = 3kΩ to 7kΩ, measured from +3.0V to -3.0V or -3.0V to +3.0V, one transmitter switching	C _L = 150pF to 1000pF	6		30	V/μs

TIMING CHARACTERISTICS—MAX3237E

(V_{CC} = +3V to +5.5V, C₁–C₄ = 0.1μF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 3)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS	
Maximum Data Rate	R _L = 3kΩ, C _L = 1000pF, one transmitter switching, MBAUD = GND		250			kbps	
	V _{CC} = +3.0V to +4.5V, R _L = 3kΩ, C _L = 250pF, one transmitter switching, MBAUD = V _{CC}		1000				
	V _{CC} = +4.5V to +5.5V, R _L = 3kΩ, C _L = 1000pF, one transmitter switching, MBAUD = V _{CC}		1000				
Receiver Propagation Delay	R _{IN} to R _{OUT} , C _L = 150pF	t _{PHL}	0.15			μs	
		t _{PLH}	0.15				
Receiver Output Enable Time	Normal operation		2.6			μs	
Receiver Output Disable Time	Normal operation		2.4			μs	
Transmitter Skew (Note 7)	t _{PHL} - t _{PLH} , MBAUD = GND		100			ns	
	t _{PHL} - t _{PLH} , MBAUD = V _{CC}						
Receiver Skew	t _{PHL} - t _{PLH}		50			ns	
Transition-Region Slew Rate	V _{CC} = +3.3V, R _L = 3kΩ to 7kΩ, +3.0V to -3.0V or -3.0V to +3.0V, T _A = +25°C	C _L = 150pF to 1000pF	MBAUD = GND	6		30	V/μs
			MBAUD = V _{CC}	24		150	
	C _L = 150pF to 2500pF, MBAUD = GND		4		30		

Note 3: MAX3222E/MAX3232E/MAX3241E: C₁–C₄ = 0.1μF tested at +3.3V ±10%; C₁ = 0.047μF, C₂, C₃, C₄ = 0.33μF tested at +5.0V ±10%. MAX3237E: C₁–C₄ = 0.1μF tested at +3.3V ±5%, C₁–C₄ = 0.22μF tested at +3.3V ±10%; C₁ = 0.047μF, C₂, C₃, C₄ = 0.33μF tested at +5.0V ±10%. MAX3246E: C₁–C₄ = 0.22μF tested at +3.3V ±10%; C₁ = 0.22μF, C₂, C₃, C₄ = 0.54μF tested at 5.0V ±10%.

Note 4: MAX3246E devices are production tested at +25°C. All limits are guaranteed by design over the operating temperature range.

Note 5: The MAX3237E logic inputs have an active positive feedback resistor. The input current goes to zero when the inputs are at the supply rails.

Note 6: MAX3241EEUI is specified at T_A = +25°C.

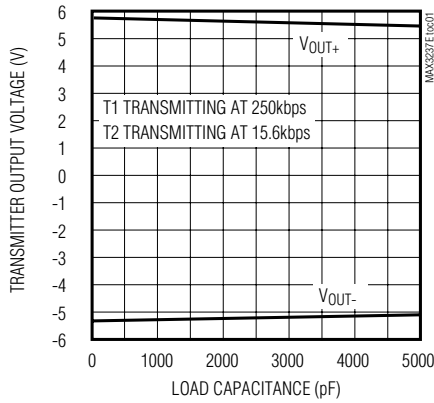
Note 7: Transmitter skew is measured at the transmitter zero crosspoints.

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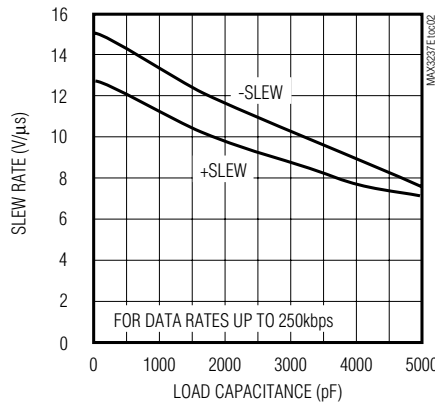
Typical Operating Characteristics

(V_{CC} = +3.3V, 250kbps data rate, 0.1μF capacitors, all transmitters loaded with 3kΩ and C_L, T_A = +25°C, unless otherwise noted.)

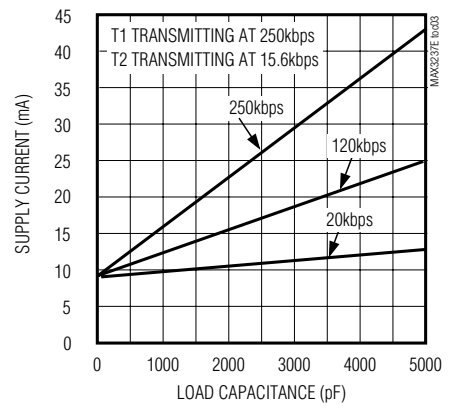
MAX3222E/MAX3232E
TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE



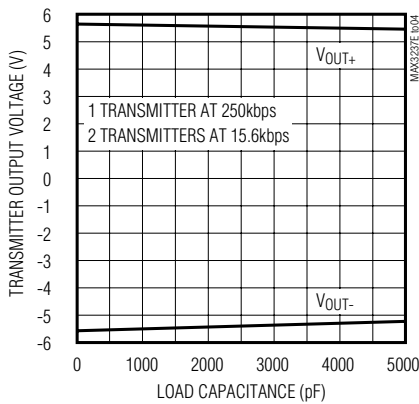
MAX3222E/MAX3232E
SLEW RATE vs. LOAD CAPACITANCE



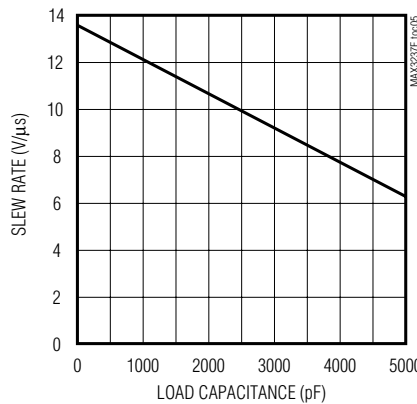
MAX3222E/MAX3232E
OPERATING SUPPLY CURRENT
vs. LOAD CAPACITANCE



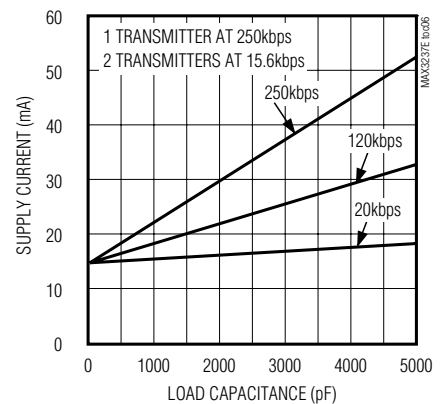
MAX3241E
TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE



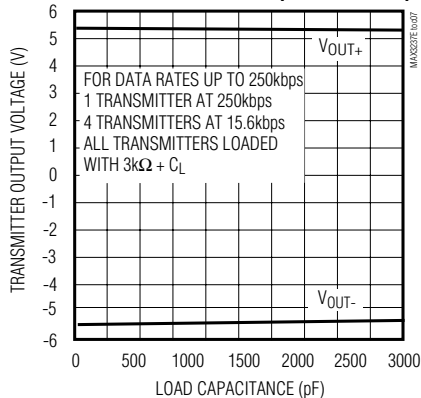
MAX3241E
SLEW RATE vs. LOAD CAPACITANCE



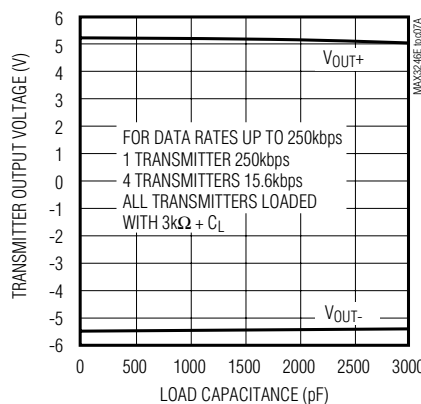
MAX3241E
OPERATING SUPPLY CURRENT
vs. LOAD CAPACITANCE



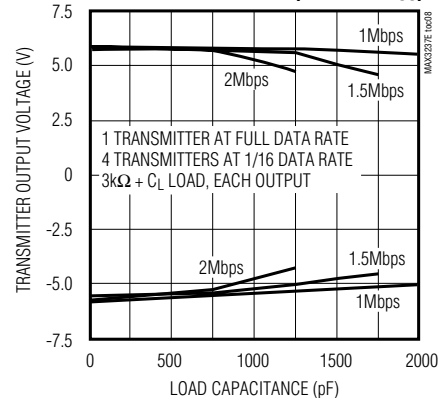
MAX3237E
TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE (MBAUD = GND)



MAX3237E
TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE



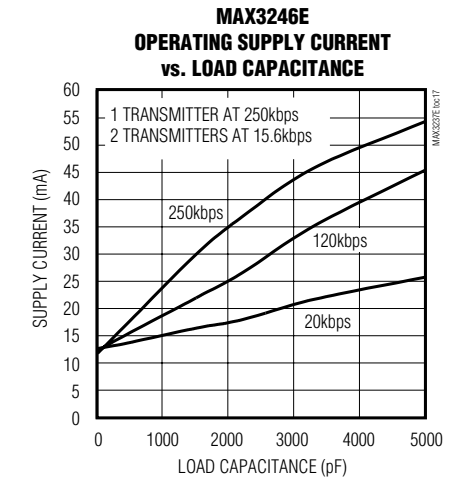
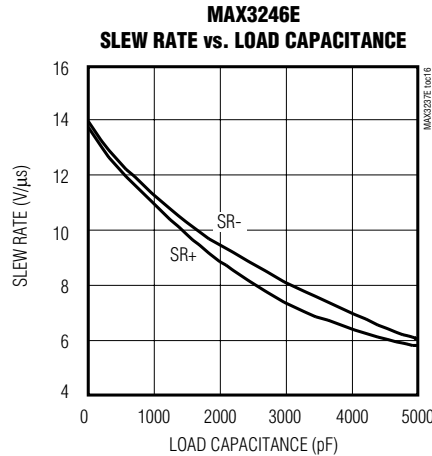
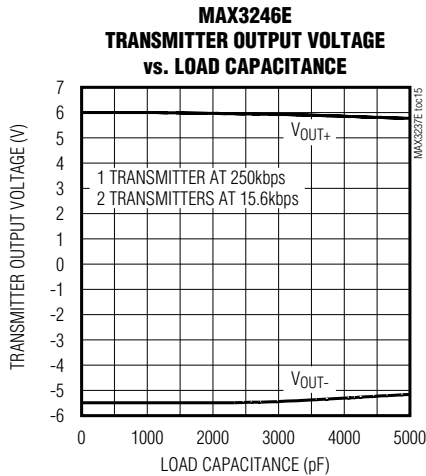
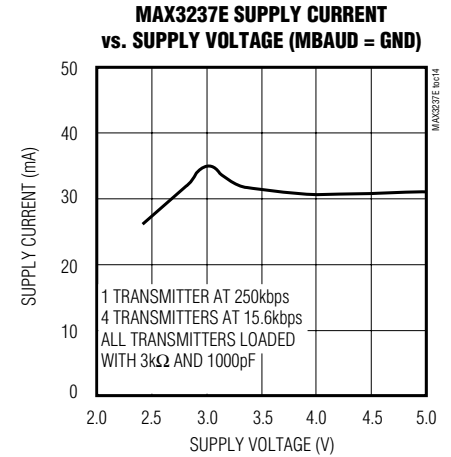
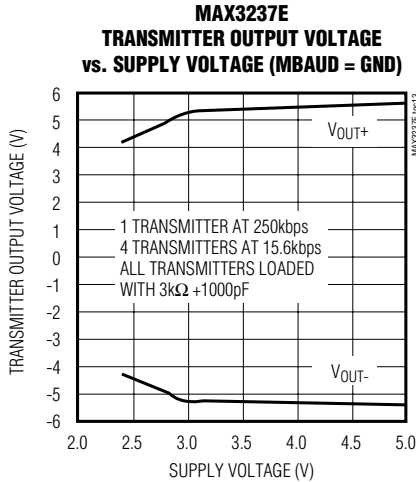
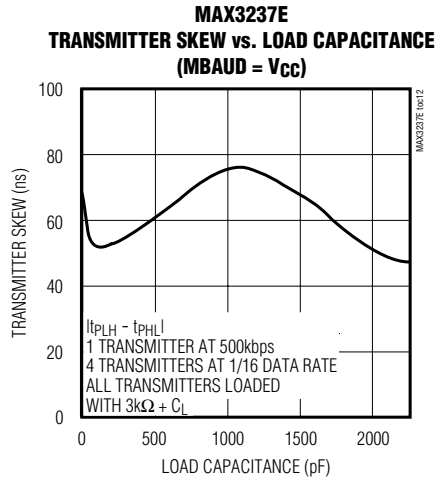
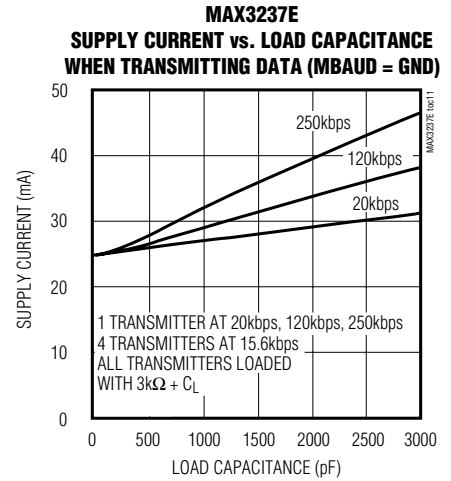
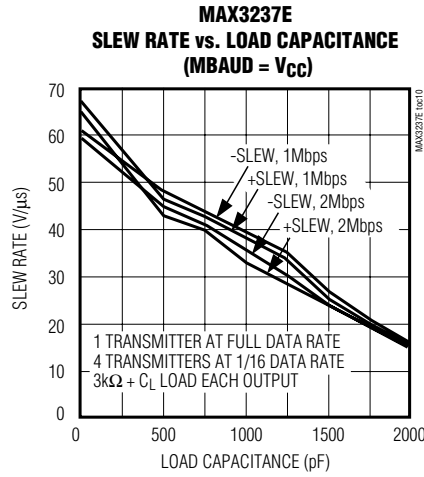
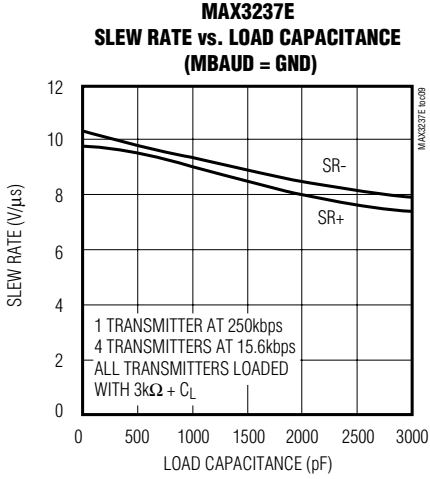
MAX3237E
TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE (MBAUD = V_{CC})



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Typical Operating Characteristics (continued)

(V_{CC} = +3.3V, 250kbps data rate, 0.1μF capacitors, all transmitters loaded with 3kΩ and C_L, T_A = +25°C, unless otherwise noted.)



±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Pin Description

PIN										NAME	FUNCTION
MAX3222E			MAX3232E			MAX3237E	MAX3241E		MAX3246E		
TQFN	SO/ DIP	TSSOP/ SSOP	TQFN	SO/DIP/ SSOP/ 16-PIN TSSOP	20-PIN TSSOP		SSOP/ SO	QFN			
19	1	1	—	—	—	13*	23	22	B3	\overline{EN}	Receiver Enable. Active low.
1	2	2	16	1	2	28	28	28	F3	C1+	Positive Terminal of Voltage-Doubler Charge-Pump Capacitor
20	3	3	15	2	3	27	27	27	F1	V+	+5.5V Generated by the Charge Pump
2	4	4	1	3	4	25	24	23	F4	C1-	Negative Terminal of Voltage-Doubler Charge-Pump Capacitor
3	5	5	2	4	5	1	1	29	E1	C2+	Positive Terminal of Inverting Charge-Pump Capacitor
4	6	6	3	5	6	3	2	30	D1	C2-	Negative Terminal of Inverting Charge-Pump Capacitor
5	7	7	4	6	7	4	3	31	C1	V-	-5.5V Generated by the Charge Pump
6, 15	8, 15	8, 17	5, 12	7, 14	8, 17	5, 6, 7, 10, 12	9, 10, 11	6, 7, 8	F6, E6, D6	T_OUT	RS-232 Transmitter Outputs
7, 14	9, 14	9, 16	6, 11	8, 13	9, 16	8, 9, 11	4–8	1–5	A4, A5, A6, B6, C6	R_IN	RS-232 Receiver Inputs
8, 13	10, 13	10, 15	7, 10	9, 12	12, 15	18, 20, 21	15–19	13, 14, 15, 17, 18	C2, B1, A1, A2, A3	R_OUT	TTL/CMOS Receiver Outputs
10, 11	11, 12	12, 13	8, 9	10, 11	13, 14	17*, 19*, 22*, 23*, 24*	12, 13, 14	10, 11, 12	E3, E2, D2	T_IN	TTL/CMOS Transmitter Inputs

*These pins have an active positive feedback resistor internal to the MAX3237E, allowing unused inputs to be left unconnected.

MAX3222E/MAX3232E/MAX3237E/MAX3241E[†]/MAX3246E

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Pin Description (continued)

PIN										NAME	FUNCTION
MAX3222E			MAX3232E			MAX3237E	MAX3241E		MAX3246E		
TQFN	SO/ DIP	TSSOP/ SSOP	TQFN	SO/DIP/ SSOP/ 16-PIN TSSOP	20-PIN TSSOP		SSOP/ SO/ TSSOP	QFN			
16	16	18	13	15	18	2	25	24	F5	GND	Ground
17	17	19	14	16	19	26	26	26	F2	V _{CC}	+3.0V to +5.5V Supply Voltage
18	18	20	—	—	—	14*	22	21	B2	$\overline{\text{SHDN}}$	Shutdown Control. Active low.
9, 12	—	11, 14	—	—	1, 10, 11, 20	—	—	9, 16, 25, 32	C3, D3, B4, C4, D4, E4, B5, C5, D5, E5	N.C.	No Connection. For MAX3246E, these locations are not populated with solder bumps.
—	—	—	—	—	—	15*	—	—	—	MBAUD	MegaBaud Control Input. Connect to GND for normal operation; connect to V _{CC} for 1Mbps transmission rates.
—	—	—	—	—	—	16	20, 21	19, 20	—	R_OUTB	Noninverting Complementary Receiver Outputs. Always active.
EP	—	—	EP	—	—	—	—	EP	—	GND	Exposed Paddle. Solder the exposed paddle to the ground alone or leave unconnected.

MAX3222E/MAX3232E/MAX3237E/MAX3241E†/MAX3246E

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

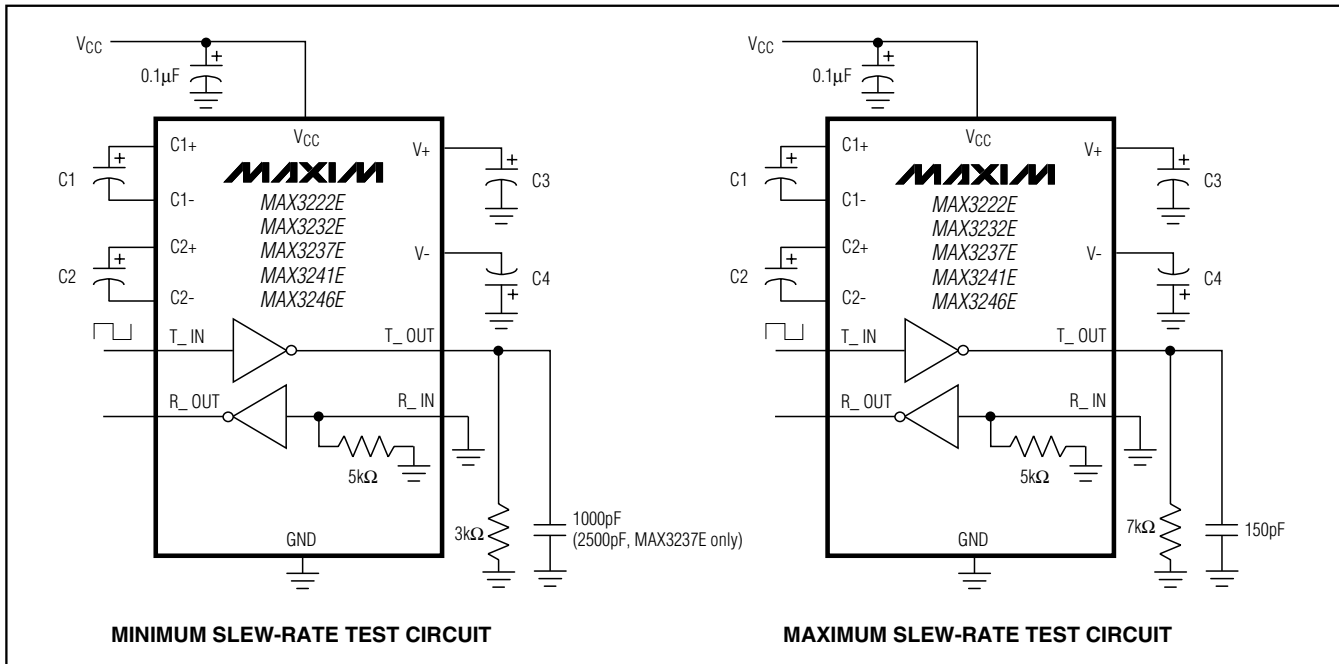


Figure 1. Slew-Rate Test Circuits

Detailed Description

Dual Charge-Pump Voltage Converter

The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246Es' internal power supply consists of a regulated dual charge pump that provides output voltages of +5.5V (doubling charge pump) and -5.5V (inverting charge pump) over the +3.0V to +5.5V VCC range. The charge pump operates in discontinuous mode; if the output voltages are less than 5.5V, the charge pump is enabled, and if the output voltages exceed 5.5V, the charge pump is disabled. Each charge pump requires a flying capacitor (C1, C2) and a reservoir capacitor (C3, C4) to generate the V+ and V- supplies (Figure 1).

RS-232 Transmitters

The transmitters are inverting level translators that convert TTL/CMOS-logic levels to ±5V EIA/TIA-232-compliant levels.

The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E transmitters guarantee a 250kbps data rate with worst-case loads of 3kΩ in parallel with 1000pF, providing compatibility with PC-to-PC communication software (such as LapLink™). Transmitters can be paralleled to drive multiple receivers or mice.

The MAX3222E/MAX3237E/MAX3241E/MAX3246E transmitters are disabled and the outputs are forced

LapLink is a trademark of Traveling Software.

into a high-impedance state when the device is in shutdown mode (SHDN = GND). The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E permit the outputs to be driven up to ±12V in shutdown.

The MAX3222E/MAX3232E/MAX3241E/MAX3246E transmitter inputs do not have pullup resistors. Connect unused inputs to GND or VCC. The MAX3237E's transmitter inputs have a 400kΩ active positive-feedback resistor, allowing unused inputs to be left unconnected.

MAX3237E MegaBaud Operation

For higher-speed serial communications, the MAX3237E features MegaBaud operation. In MegaBaud operating mode (MBAUD = VCC), the MAX3237E transmitters guarantee a 1Mbps data rate with worst-case loads of 3kΩ in parallel with 250pF for +3.0V < VCC < +4.5V. For +5V ±10% operation, the MAX3237E transmitters guarantee a 1Mbps data rate into worst-case loads of 3kΩ in parallel with 1000pF.

RS-232 Receivers

The receivers convert RS-232 signals to CMOS-logic output levels. The MAX3222E/MAX3237E/MAX3241E/MAX3246E receivers have inverting three-state outputs. Drive EN high to place the receiver(s) into a high-impedance state. Receivers can be either active or inactive in shutdown (Table 1).

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

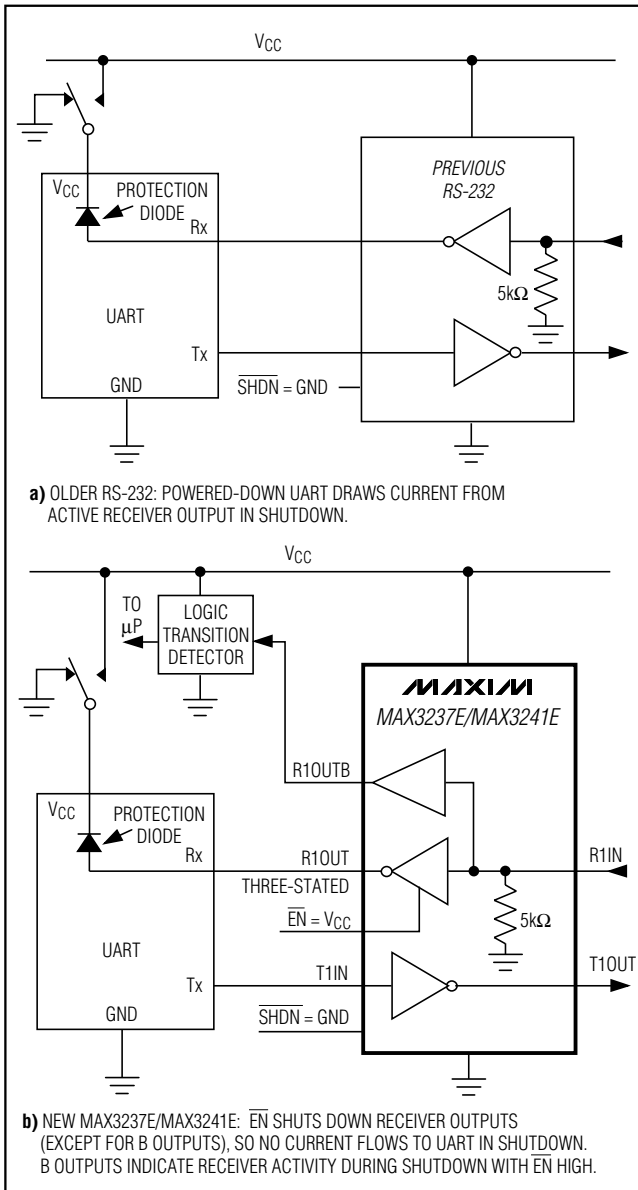


Figure 2. Detection of RS-232 Activity when the UART and Interface are Shut Down; Comparison of MAX3237E/MAX3241E (b) with Previous Transceivers (a)

The complementary outputs on the MAX3237E/MAX3241E (R_OUTB) are always active, regardless of the state of \overline{EN} or SHDN. This allows the device to be used for ring indicator applications without forward biasing other devices connected to the receiver outputs. This is ideal for systems where V_{CC} drops to zero in shutdown to accommodate peripherals such as UARTs (Figure 2).

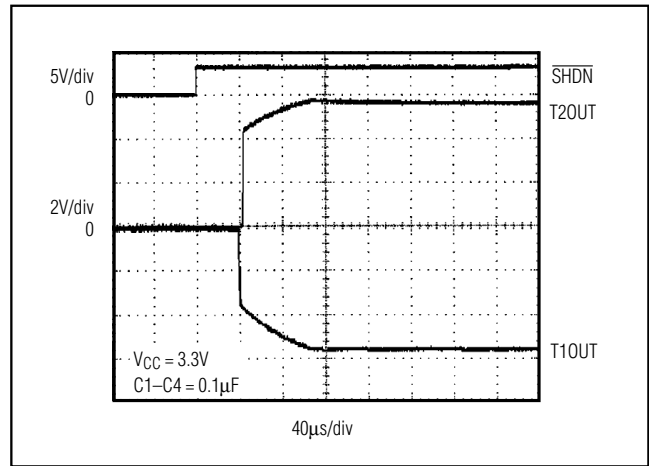


Figure 3. Transmitter Outputs Recovering from Shutdown or Powering Up

MAX3222E/MAX3237E/MAX3241E/ MAX3246E Shutdown Mode

Supply current falls to less than 1µA in shutdown mode (SHDN = low). The MAX3237E's supply current falls to 10nA (typ) when all receiver inputs are in the invalid range ($-0.3V < R_{IN} < +0.3$). When shut down, the device's charge pumps are shut off, V_+ is pulled down to V_{CC} , V_- is pulled to ground, and the transmitter outputs are disabled (high impedance). The time required to recover from shutdown is typically 100µs, as shown in Figure 3. Connect SHDN to V_{CC} if shutdown mode is not used. SHDN has no effect on R_OUT or R_OUTB (MAX3237E/MAX3241E).

±15kV ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E have extra protection against static electricity. Maxim's engineers have developed state-of-the-art structures to protect these pins against ESD of ±15kV without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, Maxim's E versions keep working without latchup, whereas competing RS-232 products can latch and must be powered down to remove latchup.

Furthermore, the MAX3237E logic I/O pins also have ±15kV ESD protection. Protecting the logic I/O pins to ±15kV makes the MAX3237E ideal for data cable applications.

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Table 1. MAX3222E/MAX3237E/MAX3241E/MAX3246E Shutdown and Enable Control Truth Table

$\overline{\text{SHDN}}$	$\overline{\text{EN}}$	T_OUT	R_OUT	R_OUTB (MAX3237E/ MAX3241E)
0	0	High impedance	Active	Active
0	1	High impedance	High impedance	Active
1	0	Active	Active	Active
1	1	Active	High impedance	Active

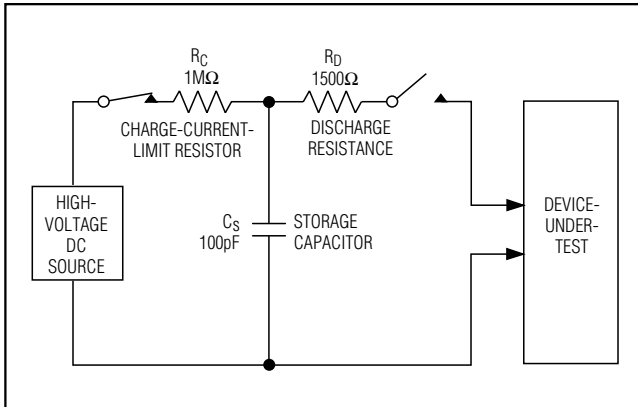


Figure 4a. Human Body ESD Test Model

ESD protection can be tested in various ways; the transmitter outputs and receiver inputs for the MAX3222E/MAX3232E/MAX3241E/MAX3246E are characterized for protection to the following limits:

- ±15kV using the Human Body Model
- ±8kV using the Contact Discharge method specified in IEC 1000-4-2
- ±9kV (MAX3246E only) using the Contact Discharge method specified in IEC 1000-4-2
- ±15kV using the Air-Gap Discharge method specified in IEC 1000-4-2

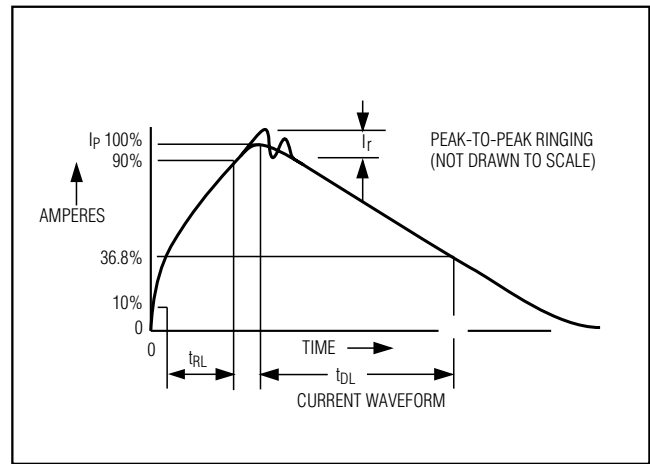


Figure 4b. Human Body Model Current Waveform

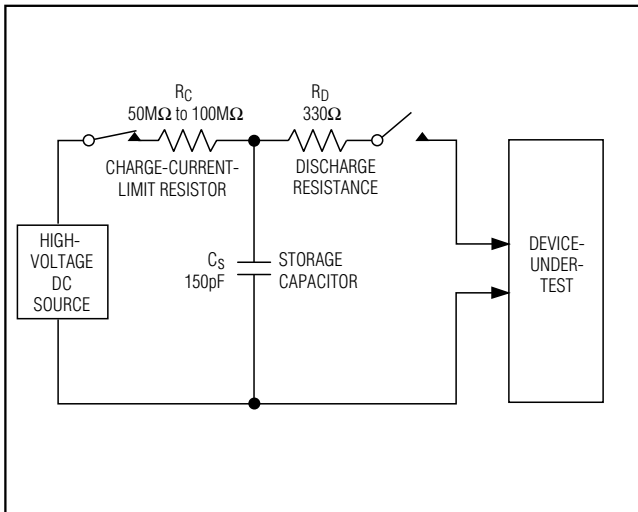


Figure 5a. IEC 1000-4-2 ESD Test Model

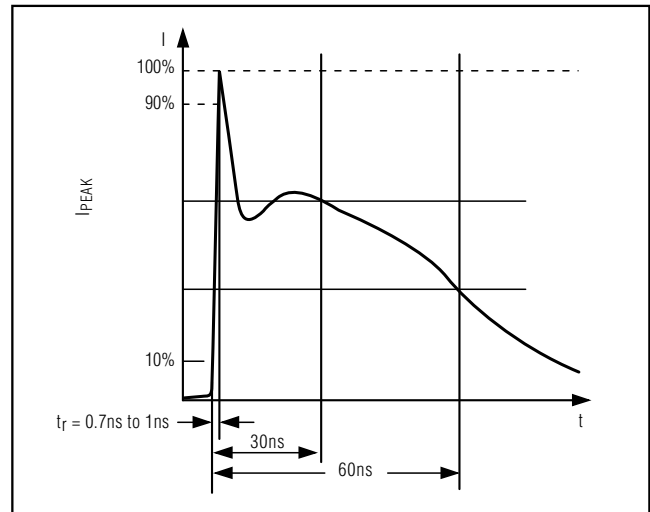


Figure 5b. IEC 1000-4-2 ESD Generator Current Waveform

MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Table 2. Required Minimum Capacitor Values

VCC (V)	C1 (µF)	C2, C3, C4 (µF)
MAX3222E/MAX3232E/MAX3241E		
3.0 to 3.6	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.1	0.47
MAX3237E/MAX3246E		
3.0 to 3.6	0.22	0.22
3.15 to 3.6	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.22	1.0

Table 3. Logic-Family Compatibility with Various Supply Voltages

SYSTEM POWER-SUPPLY VOLTAGE (V)	VCC SUPPLY VOLTAGE (V)	COMPATIBILITY
3.3	3.3	Compatible with all CMOS families
5	5	Compatible with all TTL and CMOS families
5	3.3	Compatible with ACT and HCT CMOS, and with AC, HC, or CD4000 CMOS

For the MAX3237E, all logic and RS-232 I/O pins are characterized for protection to ±15kV per the Human Body Model.

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

Human Body Model

Figure 4a shows the Human Body Model, and Figure 4b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a 1.5kΩ resistor.

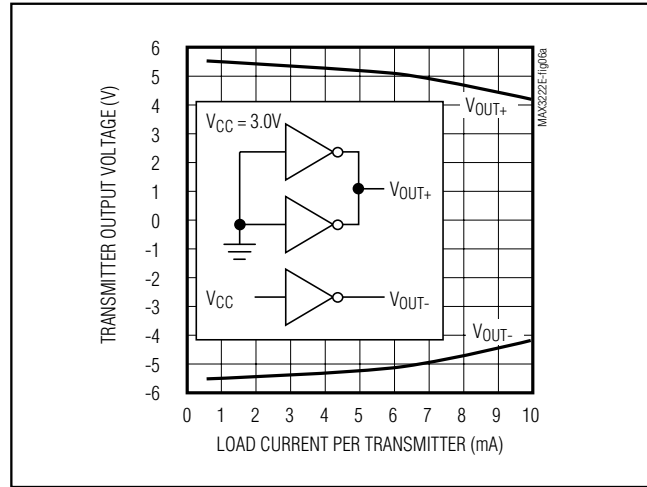


Figure 6a. MAX3241E Transmitter Output Voltage vs. Load Current Per Transmitter

IEC 1000-4-2

The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits. The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E help you design equipment that meets level 4 (the highest level) of IEC 1000-4-2, without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2, because series resistance is lower in the IEC 1000-4-2 model. Hence, the ESD withstand voltage measured to IEC 1000-4-2 is generally lower than that measured using the Human Body Model. Figure 5a shows the IEC 1000-4-2 model, and Figure 5b shows the current waveform for the ±8kV IEC 1000-4-2 level 4 ESD Contact Discharge test. The Air-Gap Discharge test involves approaching the device with a charged probe. The Contact Discharge method connects the probe to the device before the probe is energized.

Machine Model

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by contact that occurs with handling and assembly during manufacturing. All pins require this protection during manufacturing, not just RS-232 inputs and outputs. Therefore, after PC board assembly, the Machine Model is less relevant to I/O ports.

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MAX3222E/MAX3232E/MAX3237E/MAX3241E+/MAX3246E

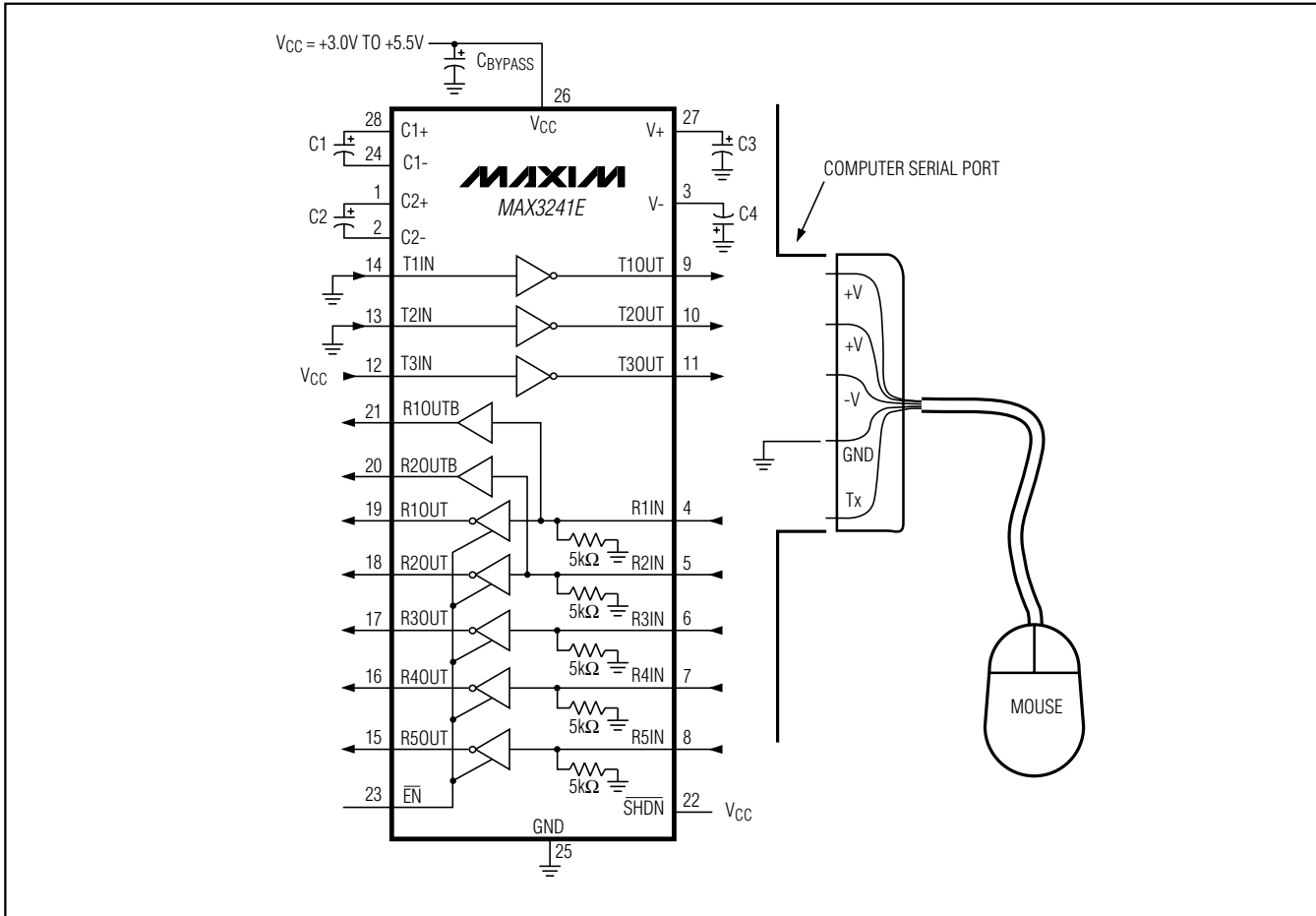


Figure 6b. Mouse Driver Test Circuit

Applications Information

Capacitor Selection

The capacitor type used for C1–C4 is not critical for proper operation; polarized or nonpolarized capacitors can be used. The charge pump requires 0.1µF capacitors for 3.3V operation. For other supply voltages, see Table 2 for required capacitor values. Do not use values smaller than those listed in Table 2. Increasing the capacitor values (e.g., by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption. C2, C3, and C4 can be increased without changing C1's value. **However, do not increase C1 without also increasing the values of C2, C3, C4, and CBYPASS to maintain the proper ratios (C1 to the other capacitors).**

When using the minimum required capacitor values, make sure the capacitor value does not degrade

excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR), which usually rises at low temperatures, influences the amount of ripple on V+ and V-.

Power-Supply Decoupling

In most circumstances, a 0.1µF VCC bypass capacitor is adequate. In applications sensitive to power-supply noise, use a capacitor of the same value as charge-pump capacitor C1. Connect bypass capacitors as close to the IC as possible.

Operation Down to 2.7V

Transmitter outputs meet EIA/TIA-562 levels of ±3.7V with supply voltages as low as 2.7V.

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Transmitter Outputs Recovering from Shutdown

Figure 3 shows two transmitter outputs recovering from shutdown mode. As they become active, the two transmitter outputs are shown going to opposite RS-232 levels (one transmitter input is high; the other is low). Each transmitter is loaded with 3kΩ in parallel with 2500pF. The transmitter outputs display no ringing or undesirable transients as they come out of shutdown. Note that

the transmitters are enabled only when the magnitude of V- exceeds approximately -3.0V.

Mouse Drivability

The MAX3241E is designed to power serial mice while operating from low-voltage power supplies. It has been tested with leading mouse brands from manufacturers such as Microsoft and Logitech. The MAX3241E successfully drove all serial mice tested and met their current and voltage requirements.

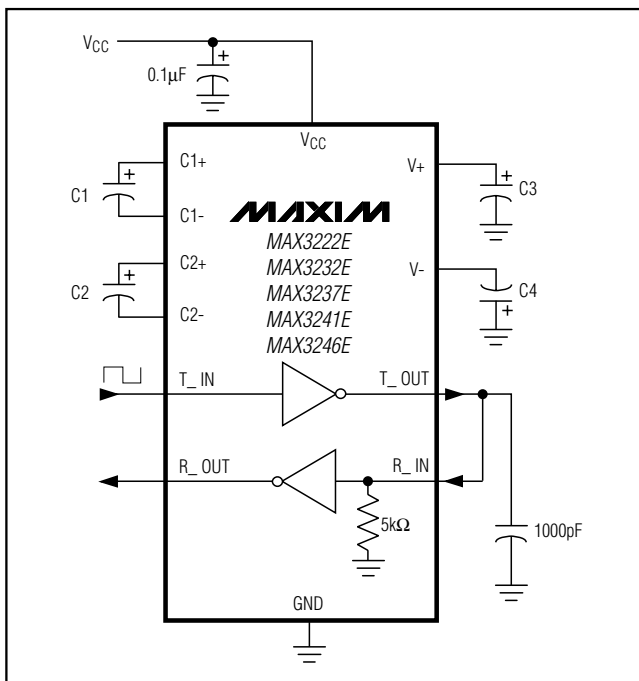


Figure 7. Loopback Test Circuit

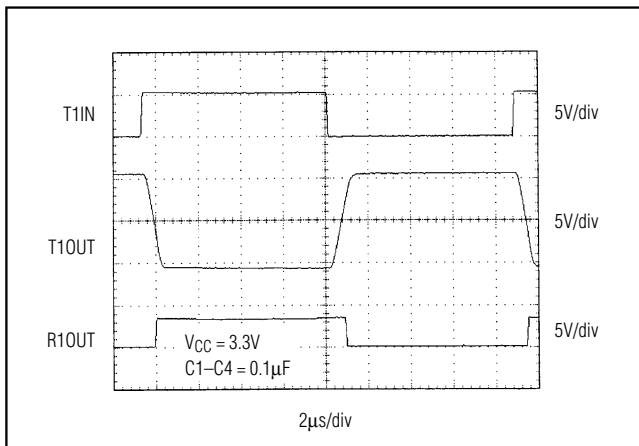


Figure 8. MAX3241E Loopback Test Result at 120kbps

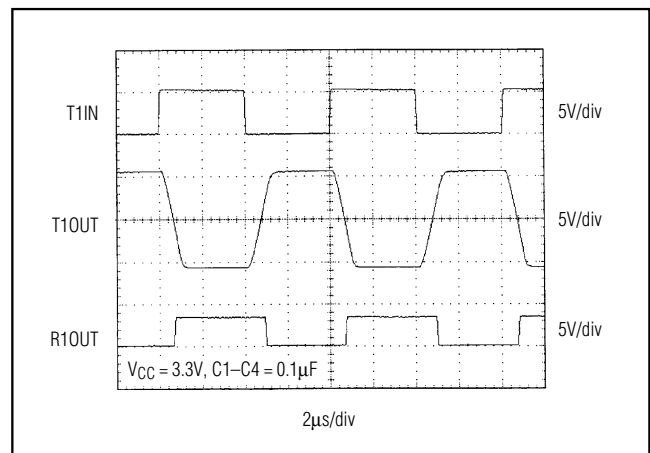


Figure 9. MAX3241E Loopback Test Result at 250kbps

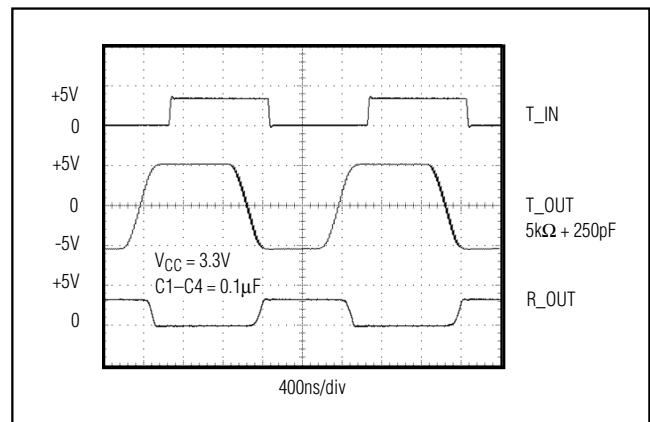


Figure 10. MAX3237E Loopback Test Result at 1000kbps (MBAUD = VCC)

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Figure 6a shows the transmitter output voltages under increasing load current at +3.0V. Figure 6b shows a typical mouse connection using the MAX3241E.

High Data Rates

The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E maintain the RS-232 ±5V minimum transmitter output voltage even at high data rates. Figure 7 shows a transmitter loopback test circuit. Figure 8 shows a loopback test result at 120kbps, and Figure 9 shows the same test at 250kbps. For Figure 8, all transmitters were driven simultaneously at 120kbps into RS-232 loads in parallel with 1000pF. For Figure 9, a single transmitter was driven at 250kbps, and all transmitters were loaded with an RS-232 receiver in parallel with 1000pF.

The MAX3237E maintains the RS-232 ±5.0V minimum transmitter output voltage at data rates up to 1Mbps. Figure 10 shows a loopback test result at 1Mbps with MBAUD = V_{CC}. For Figure 10, all transmitters were loaded with an RS-232 receiver in parallel with 250pF.

Interconnection with 3V and 5V Logic

The MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E can directly interface with various 5V logic families, including ACT and HCT CMOS. See Table 3 for more information on possible combinations of interconnections.

UCSP Reliability

The UCSP represents a unique packaging form factor that may not perform equally to a packaged product through traditional mechanical reliability tests. UCSP reliability is integrally linked to the user's assembly methods, circuit board material, and usage environment. The user should closely review these areas when considering use of a UCSP package. Performance through Operating Life Test and Moisture Resistance remains uncompromised as the wafer-fabrication process primarily determines it.

Mechanical stress performance is a greater consideration for a UCSP package. UCSPs are attached through direct solder contact to the user's PC board, foregoing the inherent stress relief of a packaged product lead frame. Solder joint contact integrity must be considered. Table 4 shows the testing done to characterize the UCSP reliability performance. In conclusion, the UCSP is capable of performing reliably through environmental stresses as indicated by the results in the table. Additional usage data and recommendations are detailed in the UCSP application note, which can be found on Maxim's website at www.maxim-ic.com.

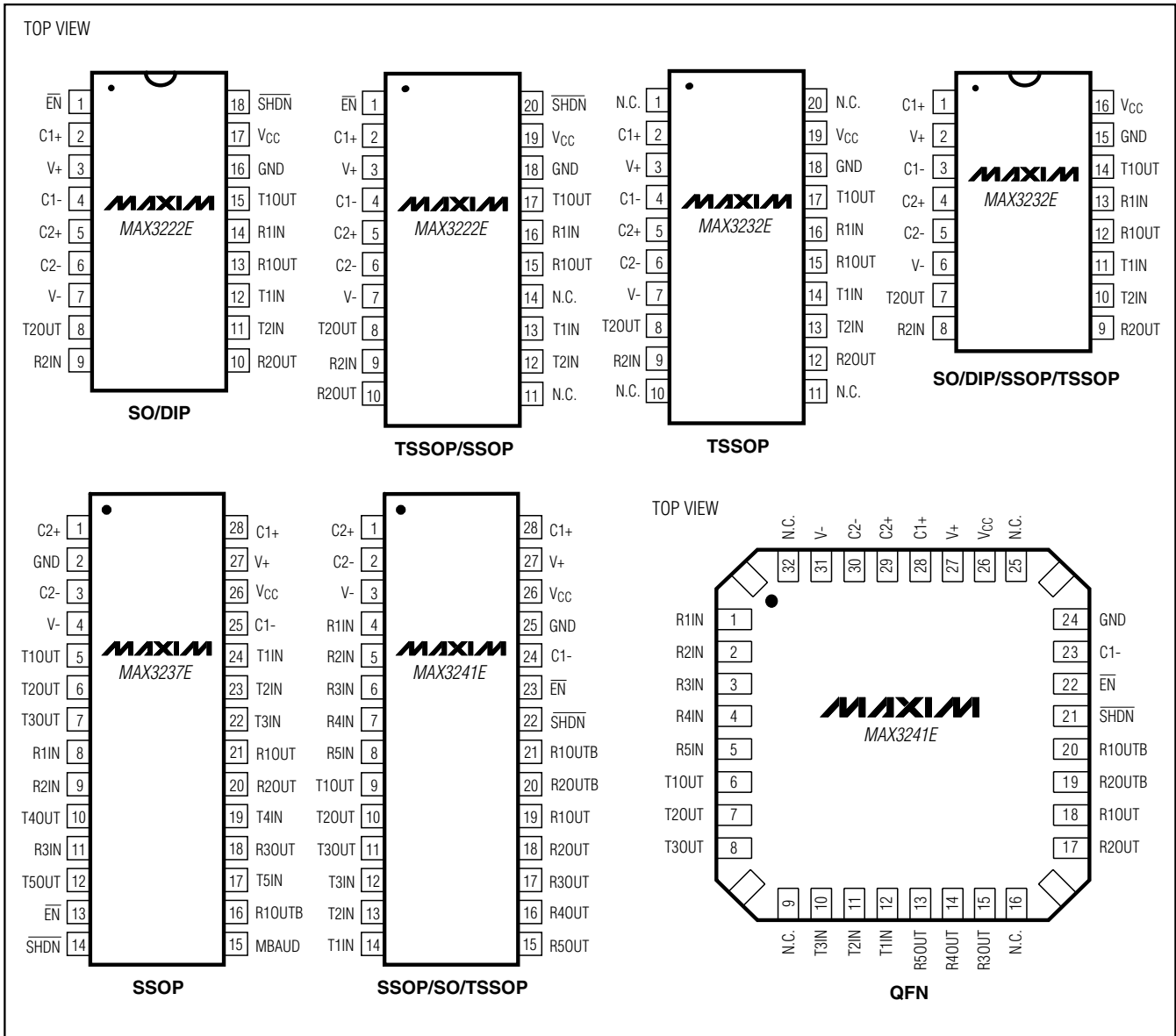
Table 4. Reliability Test Data

TEST	CONDITIONS	DURATION	FAILURES PER SAMPLE SIZE
Temperature Cycle	T _A = -35°C to +85°C, T _A = -40°C to +100°C	150 cycles, 900 cycles	0/10, 0/200
Operating Life	T _A = +70°C	240 hours	0/10
Moisture Resistance	T _A = +20°C to +60°C, 90% RH	240 hours	0/10
Low-Temperature Storage	T _A = -20°C	240 hours	0/10
Low-Temperature Operational	T _A = -10°C	24 hours	0/10
Solderability	8-hour steam age	—	0/15
ESD	±15kV, Human Body Model	—	0/5
High-Temperature Operating Life	T _J = +150°C	168 hours	0/45

MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

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Pin Configurations

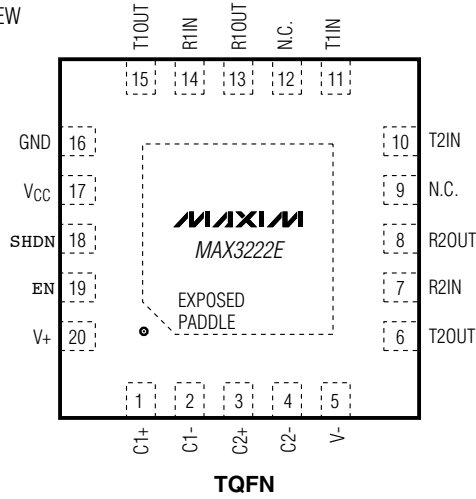


±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

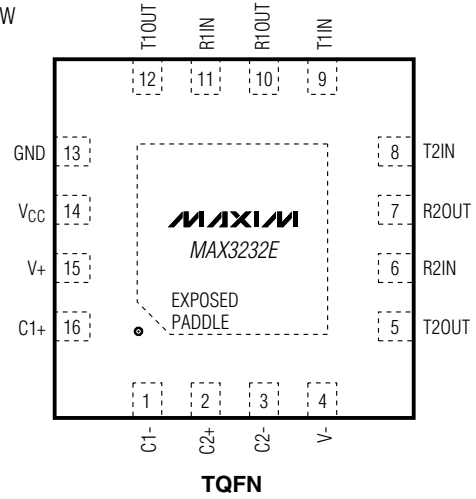
Pin Configurations (continued)

MAX3222E/MAX3232E/MAX3237E/MAX3241E[†]/MAX3246E

TOP VIEW

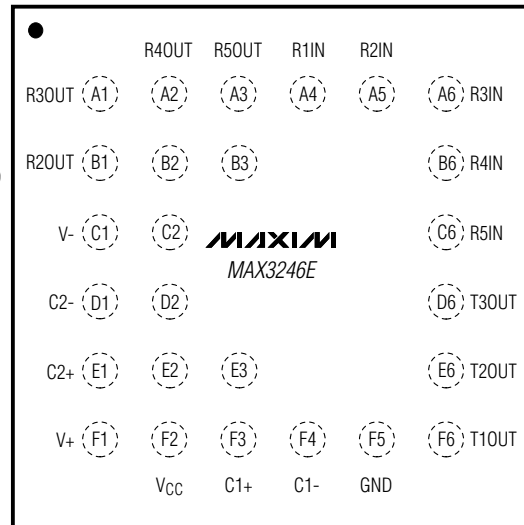


TOP VIEW



TOP VIEW
(BUMPS ON BOTTOM)

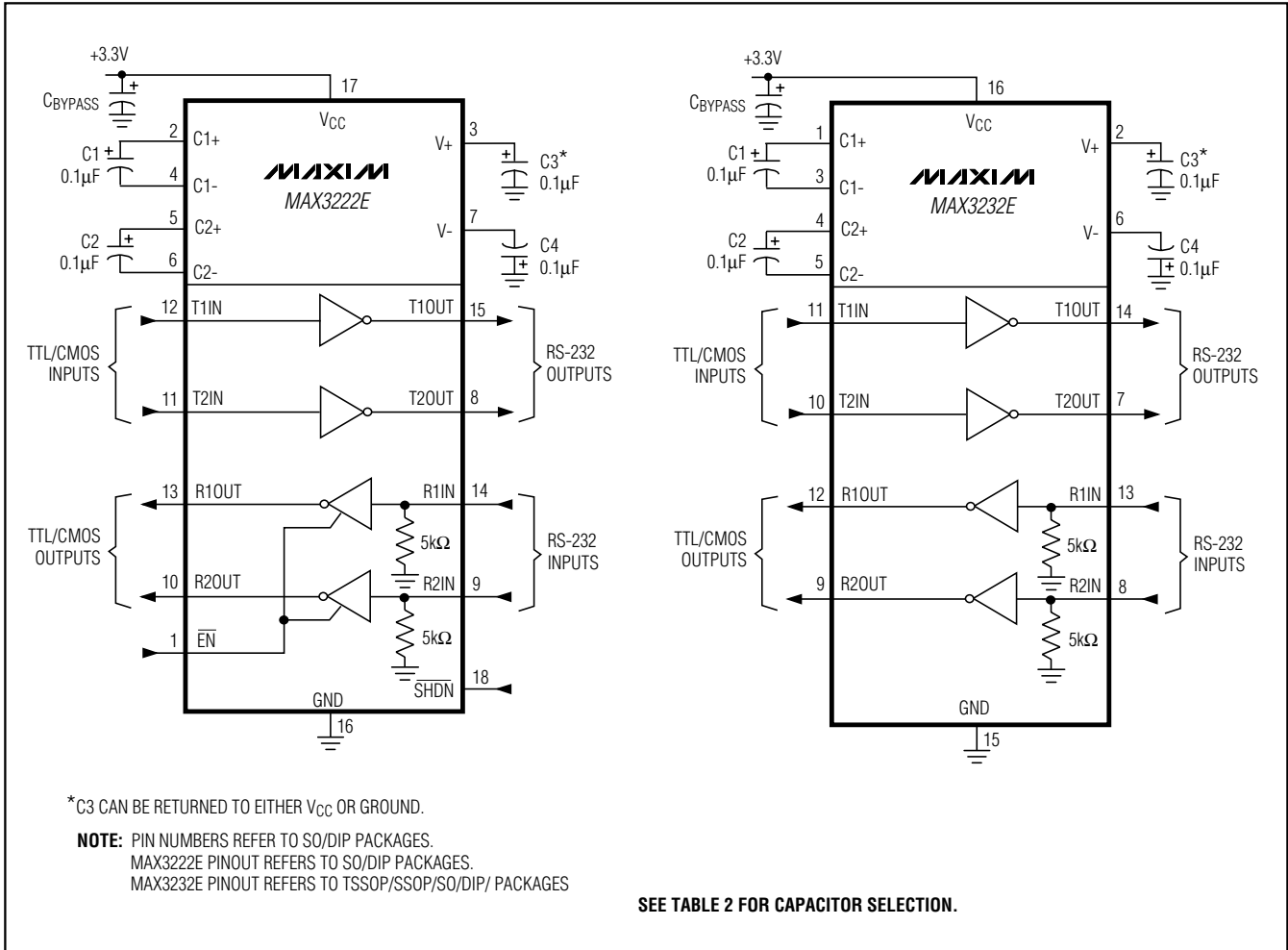
- B2: SHDN
- C2: R1OUT
- D2: T3IN
- E2: T2IN
- B3: EN
- E3: T1IN
- BUMPS B4, B5, C3, C4, C5, D3, D4, D5, E4, AND E5 NOT POPULATED



UCSP

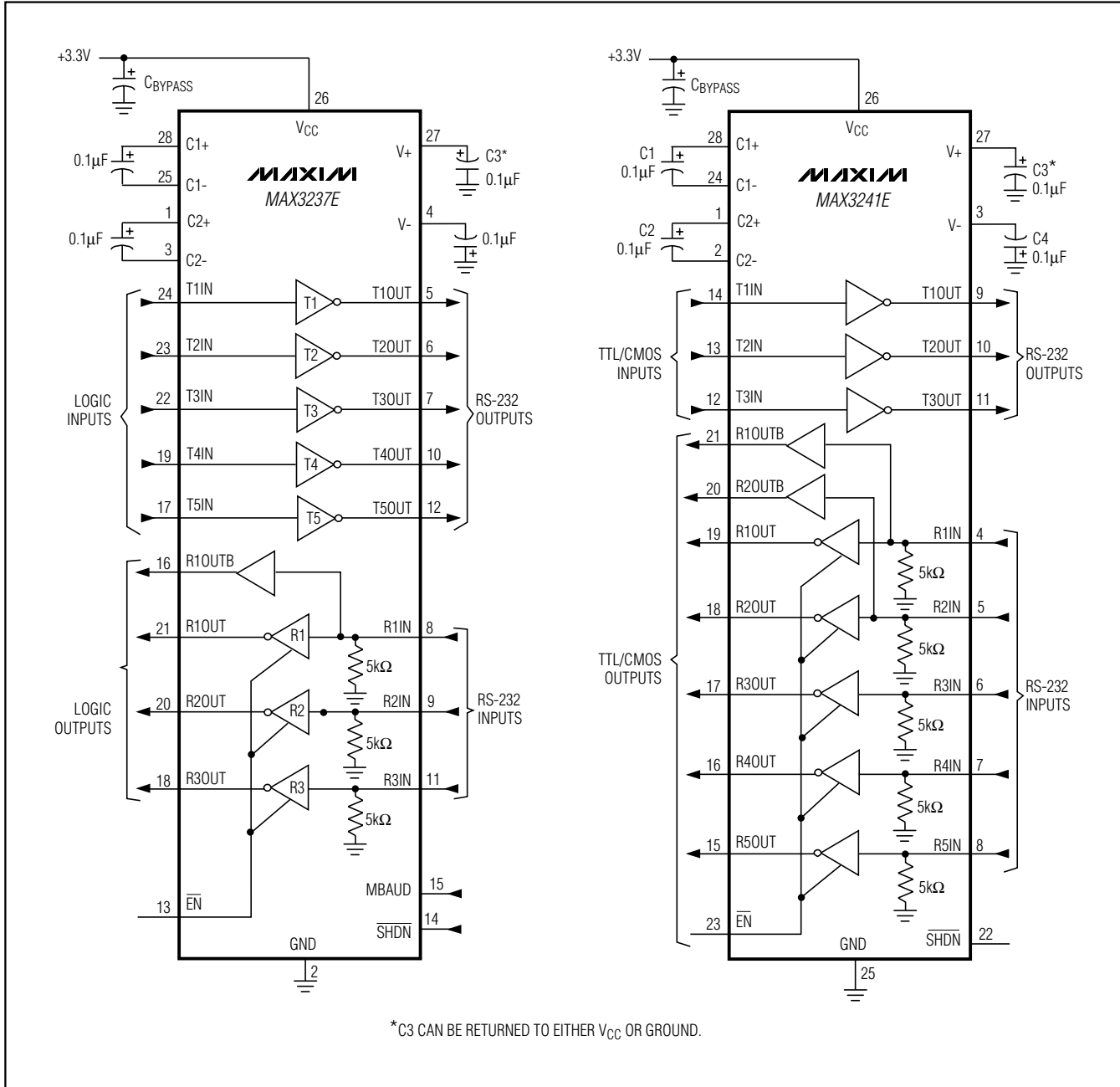
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Typical Operating Circuits



±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

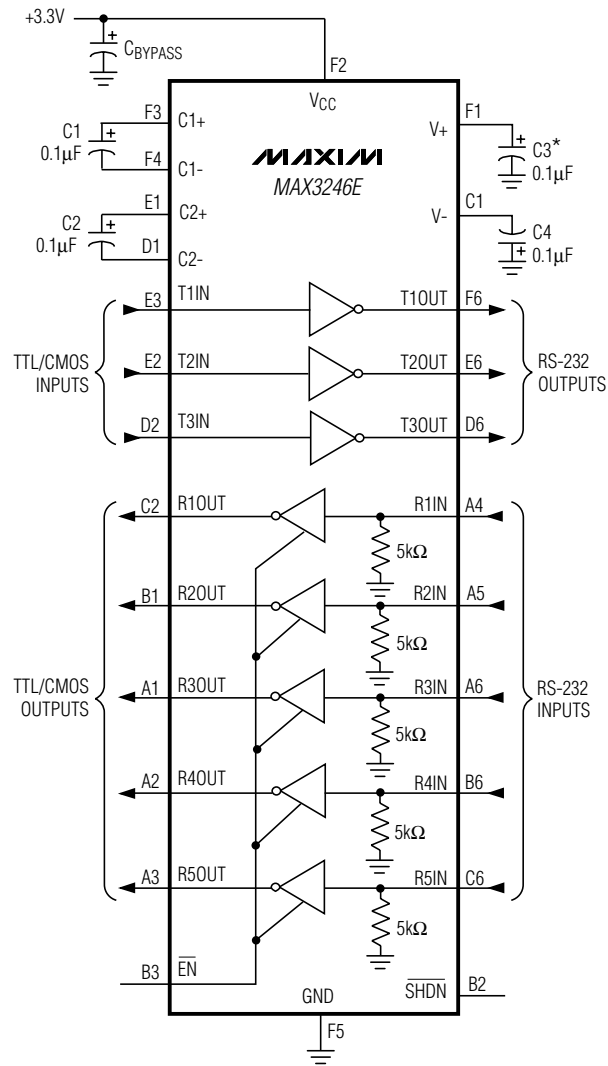
Typical Operating Circuits (continued)



MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Typical Operating Circuits (continued)



*C3 CAN BE RETURNED TO EITHER V_{CC} OR GROUND.

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Selector Guide

PART	NO. OF DRIVERS/RECEIVERS	LOW-POWER SHUTDOWN	GUARANTEED DATA RATE (bps)
MAX3222E	2/2	✓	250k
MAX3232E	2/2	—	250k
MAX3237E (Normal)	5/3	✓	250k
MAX3237E (MegaBaud)	5/3	✓	1M
MAX3241E	3/5	✓	250k
MAX3246E	3/5	✓	250k

Chip Information

TRANSISTOR COUNT:

MAX3222E/MAX3232E: 1129

MAX3237E: 2110

MAX3241E: 1335

MAX3246E: 842

PROCESS: BICMOS

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX3232ECTE	0°C to +70°C	16 Thin QFN-EP** (5mm x 5mm)	T1655-2
MAX3232ECUE	0°C to +70°C	16 TSSOP	—
MAX3232ECUP	0°C to +70°C	20 TSSOP	—
MAX3232EEAE	-40°C to +85°C	16 SSOP	—
MAX3232EEWE	-40°C to +85°C	16 Wide SO	—
MAX3232EEPE	-40°C to +85°C	16 Plastic DIP	—
MAX3232EETE	-40°C to +85°C	16 Thin QFN-EP** (5mm x 5mm)	T1655-2
MAX3232EEUE	-40°C to +85°C	16 TSSOP	—
MAX3232EEUP	-40°C to +85°C	20 TSSOP	—
MAX3237ECAI	0°C to +70°C	28 SSOP	—
MAX3237EEAI	-40°C to +85°C	28 SSOP	—
MAX3241ECAI	0°C to +70°C	28 SSOP	—
MAX3241ECWI	0°C to +70°C	28 Wide SO	—
MAX3241ECUI	0°C to +70°C	28 TSSOP	—
MAX3241ECTJ	0°C to +70°C	32 Thin QFN	—
MAX3241EEAI	-40°C to +85°C	28 SSOP	—
MAX3241EEWI	-40°C to +85°C	28 Wide SO	—
MAX3241EEUI	-40°C to +85°C	28 TSSOP	—
MAX3246ECBX-T	0°C to +70°C	6 x 6 UCSP†	—
MAX3246EEBX-T	-40°C to +85°C	6 x 6 UCSP†	—

†Requires solder temperature profile described in the Absolute Maximum Ratings section. UCSP Reliability is integrally linked to the user's assembly methods, circuit board material, and environment. Refer to the UCSP Reliability Notice in the UCSP Reliability section of this datasheet for more information.

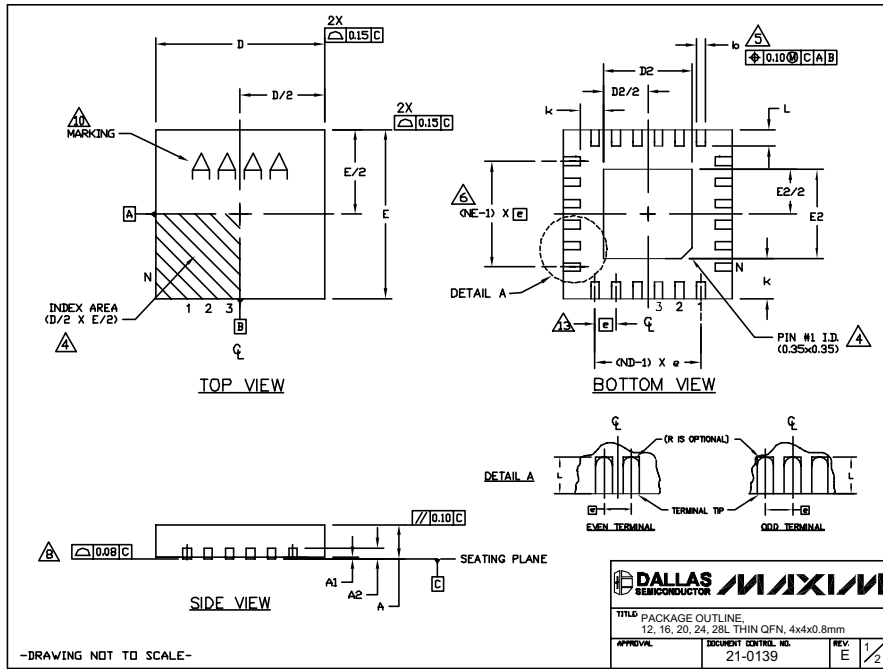
**EP = Exposed paddle.

MAX3222E/MAX3232E/MAX3237E/MAX3241E†/MAX3246E

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Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



COMMON DIMENSIONS															
PKG REF.	12L 4x4			16L 4x4			20L 4x4			24L 4x4			28L 4x4		
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05
A2	0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
E	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
e	0.80 BSC.			0.65 BSC.			0.50 BSC.			0.50 BSC.			0.40 BSC.		
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N	12			16			20			24			28		
ND	3			4			5			6			7		
NE	3			4			5			6			7		
WGGC	VGG3			VGGC			WGGD-1			WGGD-2			WGGE		

EXPOSED PAD VARIATIONS												
PKG CODES	D2			E2			DOWN BOND ALLOWED					
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.						
T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	YES					
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	NO					
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES					
T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	NO					
T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	YES					
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	NO					
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES					
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES					
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	NO					
T2844-1	2.50	2.60	2.70	2.50	2.60	2.70	NO					

NOTES:

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JEDEC 95-1 SFP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TP.
- ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- DRAWING CONFORMS TO JEDEC W0220, EXCEPT FOR T2444-3, T2444-4 AND T2844-1.
- MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- COPLANARITY SHALL NOT EXCEED 0.08mm
- WARPAGE SHALL NOT EXCEED 0.10mm
- LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.
- NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

DALLAS SEMICONDUCTOR MAXIM
 TITLE PACKAGE OUTLINE, 12, 16, 20, 24, 28L THIN QFN, 4x4x0.8mm
 APPROVAL DOCUMENT CONTROL NO. 21-0139 REV. E 1/2

-DRAWING NOT TO SCALE-

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

	COMMON DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	—	1.10	—	.043
A ₁	0.05	0.15	.002	.006
A ₂	0.85	0.95	.033	.037
b	0.19	0.30	.007	.012
b ₁	0.19	0.25	.007	.010
c	0.09	0.20	.004	.008
c ₁	0.09	0.14	.004	.006
D	SEE VARIATIONS		SEE VARIATIONS	
E	4.30	4.50	.169	.177
e	.65 BSC		.026 BSC	
H	6.25	6.55	.246	.258
L	0.50	0.70	.020	.028
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°
bblo	0.10 MAX			

JEDEC MD-153	N	PKG. CODES	VARIATIONS			
			MILLIMETERS		INCHES	
			MIN.	MAX.	MIN.	MAX.
AB-1	14	D U14-1J U14-2	4.90	5.10	.193	.201
AB	16	D U16-1J U16-2	4.90	5.10	.193	.201
AC	20	D U20-2J U20-3	6.40	6.60	.252	.260
AD	24	D U24-1	7.70	7.90	.303	.311
AE	28	D U28-1J; U28-2J U28-3	9.60	9.80	.378	.386

NOTES

- DIMENSIONS D AND E DO NOT INCLUDE FLASH
- MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm PER SIDE
- CONTROLLING DIMENSION: MILLIMETER
- MEETS JEDEC OUTLINE MD-153. SEE JEDEC VARIATIONS TABLE
- "N" REFERS TO NUMBER OF LEADS
- LEAD COPLANARITY 0.10 MM MAX.
- NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY
- MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY
- BENT LEAD 0.10 MM MAX.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR **MAXIM**

TITLE: PACKAGE OUTLINE, TSSOP 4.40mm BODY

APPROVAL: DOCUMENT CONTROL NO. 21-0066 REV. 1 1/1

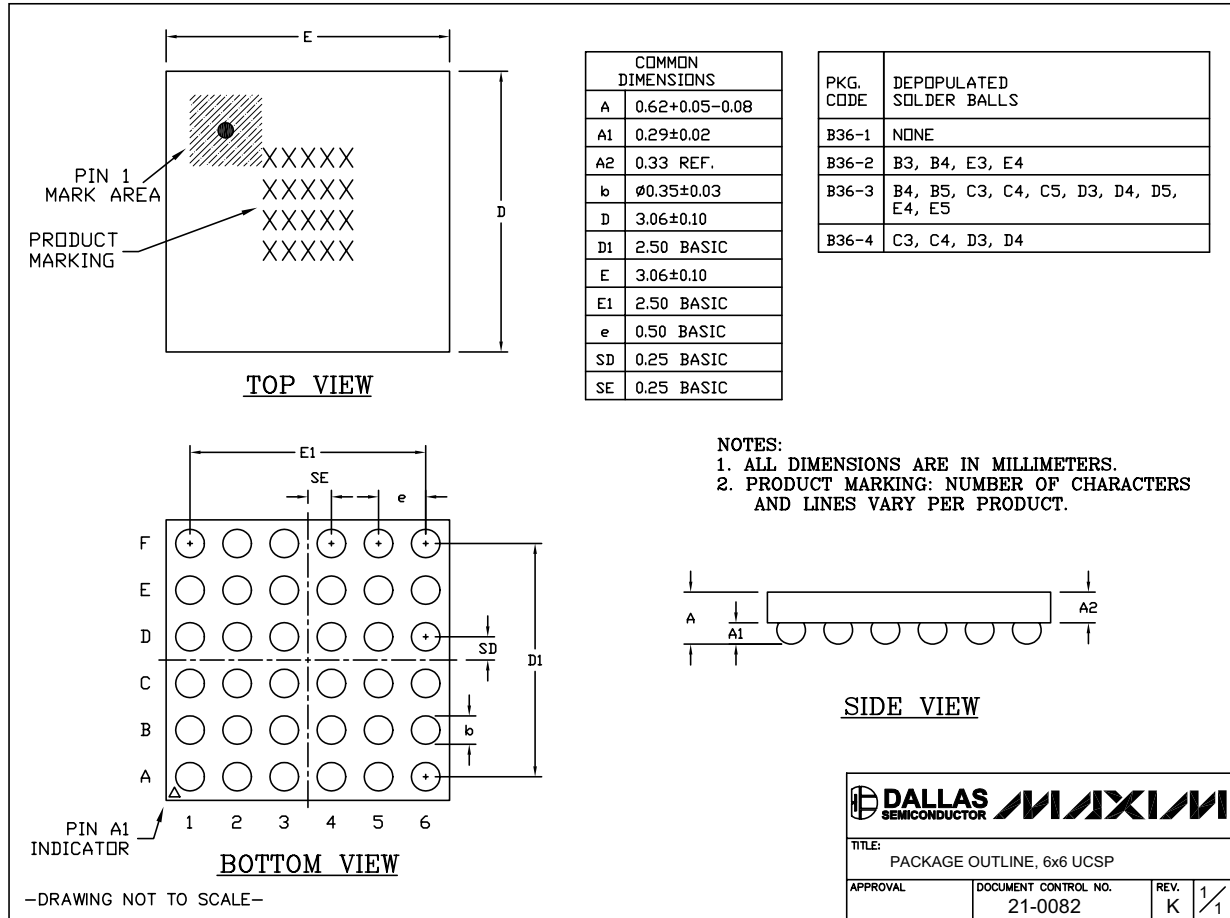
TSSOP4, 4.0mm EPS

MAX3222E/MAX3232E/MAX3237E/MAX3241E/MAX3246E

±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



36_LUCSP.EPS

DALLAS SEMICONDUCTOR **MAXIM**

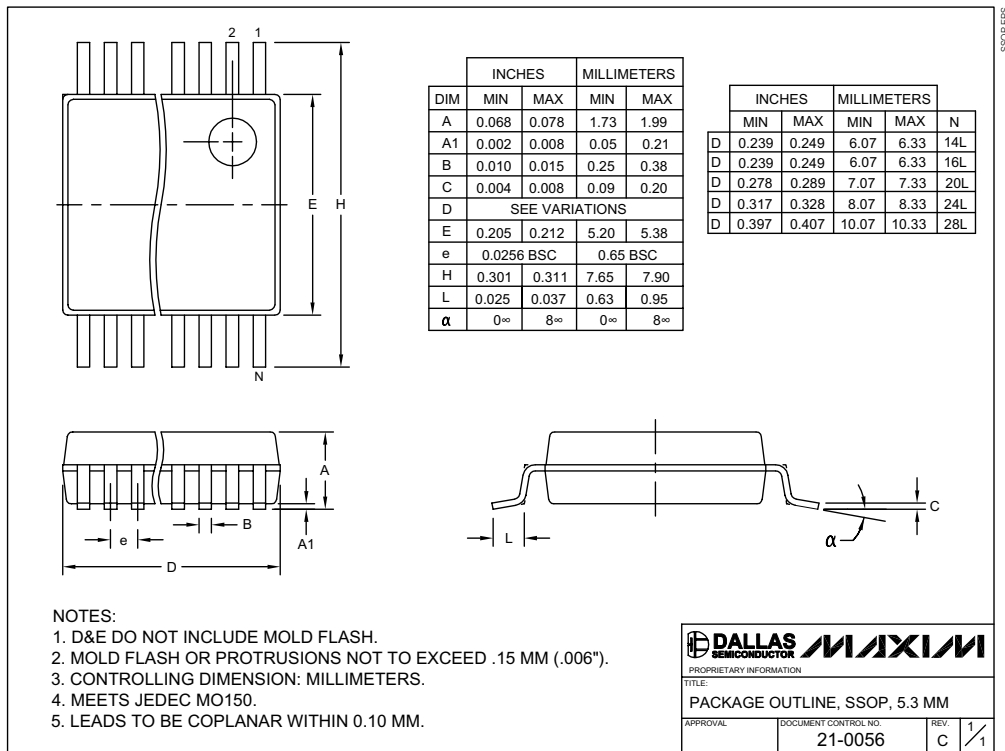
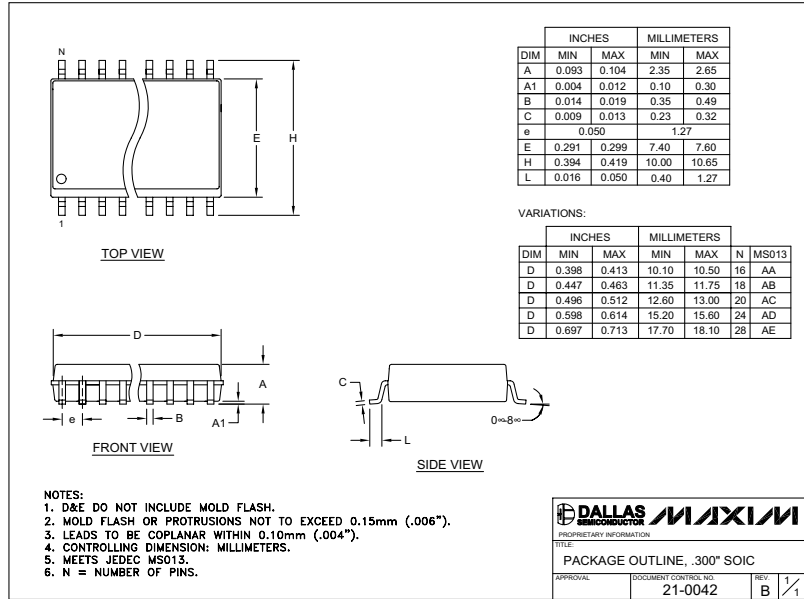
TITLE: PACKAGE OUTLINE, 6x6 UCSP

APPROVAL	DOCUMENT CONTROL NO. 21-0082	REV. K	1/1
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±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Package Information (continued)

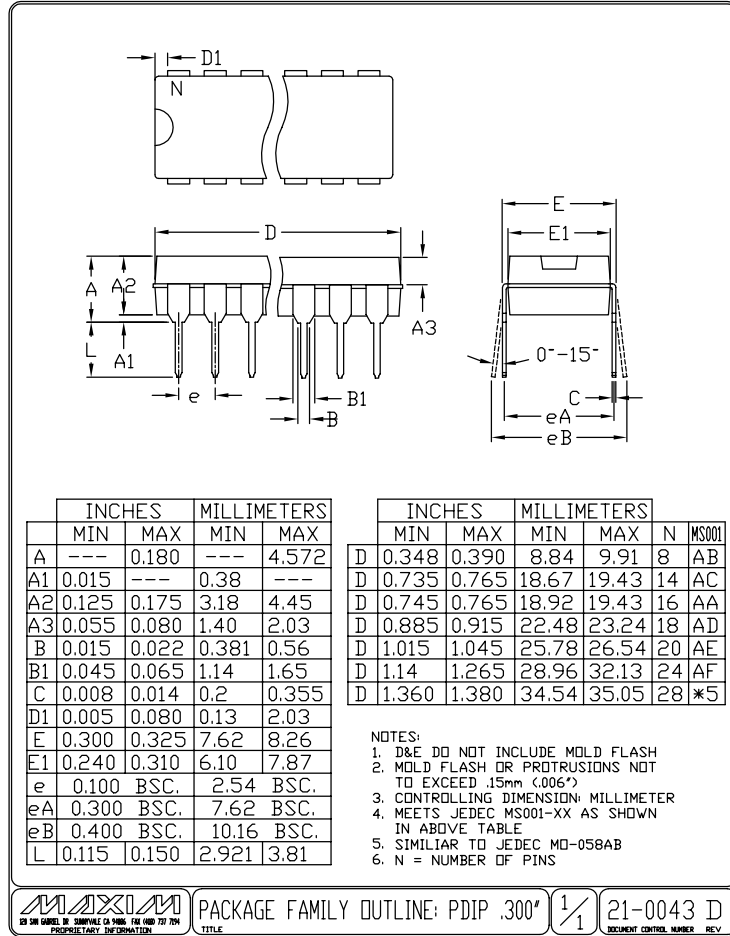
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



±15kV ESD-Protected, Down to 10nA, 3.0V to 5.5V, Up to 1Mbps, True RS-232 Transceivers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



Revision History

Pages changed at Rev 10: 1-4, 9, 11, 21, 22, 26

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